# **<b>&TDK** Multilayer Ceramic Chip Capacitors

## C1608X5R0J106K080AE



### TDK item description C1608X5R0J106KT\*\*\*S

Applications	Commercial Grade	
Feature	Soft Soft Termination	
Series	C1608 [EIA 0603]	
Status	Production	



	Size
Length(L)	1.60mm +0.25,-0.10mm
Width(W)	0.80mm +0.20,-0.10mm
Thickness(T)	0.80mm +0.20,-0.10mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.30mm Min.
Decommended Land Dettern (DA)	0.70mm to 1.00mm(Flow Soldering)
Recommended Land Pattern (PA)	0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PB)	0.80mm to 1.00mm(Flow Soldering)
	0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.60mm to 0.80mm(Flow Soldering)
	0.60mm to 0.80mm(Reflow Soldering)

Electrical Characteristics		
Capacitance	10µF ±10%	
Rated Voltage	6.3VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	10%	
Insulation Resistance (Min.)	10ΜΩ	

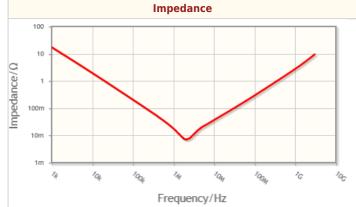
	Other
Soldering Method	Wave (Flow)
	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	4000pcs

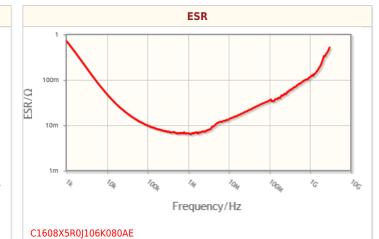
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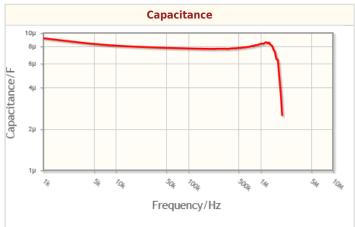
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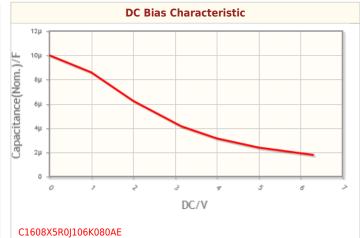


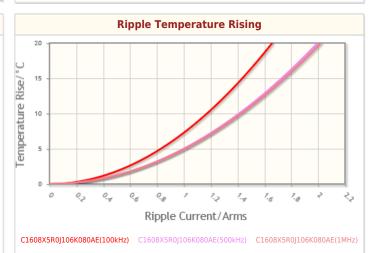




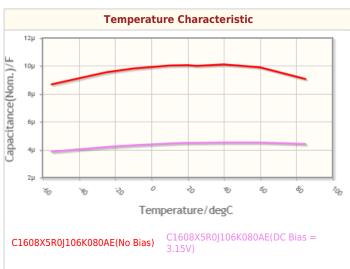
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Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

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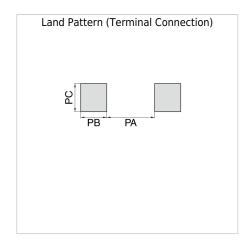
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# Associated Images



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